

MAX24003

2.5Gbps Tx Burst-Mode Laser Transceiver

General Description

Features

The MAX24003 is a complete burst-mode laser driver transmitter and limiting amplifier receiver used within fiber optic modules for FTTx applications. A fully compliant GEPON module with digital diagnostics is realized when used with a 2KB EEPROM and suitable optics. Alternatively, a microcontroller is used in conjunction with the MAX24003; however, this is not a necessity to achieve SFF-8472 compliance.

The 2.5Gbps limiting receive path features programmable output swing control, rate selection, and OMA-based loss-of-signal detection.

The burst-mode laser driver has temperaturecompensated modulation control using a lookup table. Closed-loop control of laser power incorporates tracking error compensation and has multiple options for rapidly settling the laser power thus enabling fast registration and shutdown on the network. Diagnostics are enhanced with the inclusion of programmable transmit signal detection during bursts, and rogue ONU detection between bursts. This is linked to a laser safety system, which allows the modulation and bias currents to be shut off in response to a range of different fault conditions detected on-chip.

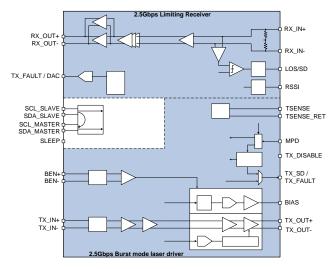
The transmit and receive systems are independently powered and respond separately to the SLEEP pin. The MAX24003 is highly configurable from either EEPROM or low-cost MCU using a twowire interface.

Applications

GPON, GEPON, Gigabit Ethernet

2.5Gbps Limiting Receiver
OMA-Based LOS Detection
1.25Gbps to 2.5Gbps Laser Driver
CML, LVPECL, HSTL, SSTL-Compatible Inputs
Open and Closed-Loop Bias Control
Temperature-Compensated I_{MOD} Control
Highly Configurable Laser Safety System
Transmit TX_SD and Rogue ONU Detection
SFP MSA and SFF-8472 Digital Diagnostics
Integrated Temperature Sensor
Power-Saving SLEEP Modes
External DAC Interface

Functional Diagram



Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX24003TL+	-40°C to +95°C	40 TQFN-EP*

⁺Denotes a lead(Pb)-free/RoHS-compliant package.
*EP = Exposed Pad

19-6545; Rev 0; 12/12 Maxim Integrated 1

Some revisions of this device may incorporate deviations from published specifications known as errata. Multiple revisions of any device may be simultaneously available through various sales channels. For information about device errata, go to: www.maximintegrated.com/errata. For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maximintegrated.com.

ABSOLUTE MAXIMUM RATINGS

Voltage Range on V _{DD TX} , V _{DD TXO} , V _{DD RX} , V _{DD RXO}	0.3V to +3.65V
Voltage Range on Any Pin Not Otherwise Specified (with respect to V _{SS} *)	
Continuous Power Dissipation (T _A = +70°C)	, _ ,
TQFN (derate 35.7mW/°C above +70°C)	2857.1mW
Operating Temperature Range	40°C to +95°C
Junction Temperature	+150°C
Storage Temperature	
Lead Temperature (soldering, 10s)	
Soldering Temperature (reflow)	+260°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

RECOMMENDED DC OPERATING CONDITIONS

(Device not guaranteed to meet parametric specifications. Permanent damage may be incurred by operating beyond these limits.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating Supply Voltage	V_{DD}		3.0	3.3	3.6	V
RSSI Compliance		ROSA sourcing to RSSI pin			V _{DD} - 0.75	V
•		ROSA sinking from RSSI pin	0.75			V
BIAS Compliance			0.8			V
TX_OUT Compliance			0.8			V
MPD Input Current		For correct APC loop operation	40		2000	μΑ
MPD Input Capacitance		For correct APC loop operation	4		20	pF
Junction Temperature			-40		+120	°C
Case Temperature			-40		+95	°C

ELECTRICAL CHARACTERISTICS

 $(V_{CC} = 2.97V \text{ to } +3.63V, T_A = -40^{\circ}\text{C to } +95^{\circ}\text{C.}) \text{ (Note 1)}$

CONTINUOUS RATINGS

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Current	I _{DD}	Excluding laser bias and modulation currents, 20mA bias and modulation current, Rx CML output 400mV _{P-P}		136		mA

Note 1: Electrical specifications are production tested at $T_A = +25^{\circ}C$. Specifications over the entire operating temperature range are guaranteed by design and characterization. Typical specifications are at $T_A = +25^{\circ}C$, 3.3V.

RECEIVER CHARACTERISTICS

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Differential Input Impedance			80	100	120	Ω
Maximum Input Data Rate				2.5		Gbps
Minimum Input Data Rate				1.25		Gbps
Input Sensitivity		Differential, BER = 1E-10, 2.5Gbps, PRBS 2 ²³ -1 pattern		6.5	13	mV _{P-P}
Deterministic Jitter		2.5Gbps, V_{OUT} = 800m V_{P-P} , V_{IN} between 25m V_{P-P} differential and 1000m V_{P-P}		40		ps _{P-P}
Random Jitter		2.5Gbps, V_{OUT} = 800m V_{P-P} , V_{IN} between 25m V_{P-P} differential and 1000m V_{P-P}		2.7		ps _{RMS}
Output Rise/Fall Times		2.5Gbps, V_{OUT} = 800m V_{P-P} , V_{IN} = 25m V_{P-P} differential and 1000m V_{P-P}		60		ps
Low-Frequency Cutoff				30		kHz
Output Impedance		1MHz differential	80	100	120	Ω
Minimum Output Swing		Differential, 4-bit programmable (Note 2)		200	240	mV_{P-P}
Maximum Output Swing		Differential, 4-bit programmable (Note 2)	800	880		mV _{P-P}

Note 2: Measured with 1111111100000000 pattern.

LOSS OF SIGNAL AND RSSI CHARACTERISTICS

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Maximum OMA LOS Assert time				11		ms
Maximum OMA LOS Deassert time				11		ms
Maximum LOS Threshold Setting				400		mV _{P-P}
LOS Assert/Deassert Level		LOS DAC = 50 (Note 3)		67		mV_{P-P}
LOS Asserv Deassert Lever		LOS DAC = 105 (Note 3)		143		mV _{P-P}
Maximum RSSI Current Level		Sourced or sunk from RSSI pin		1200		μΑ

Note 3: LOS assert and deassert levels are set independently to define hysteresis.

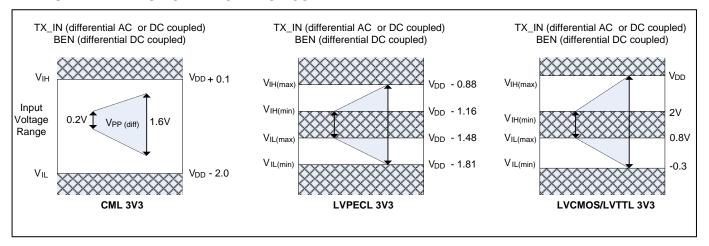
TRANSMITTER CHARACTERISTICS

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Maximum Input Data Rate		PRBS23		2.488		Gbps
Minimum Input Data Rate		PRBS23		1.25		Gbps
Maximum Modulation Current			80			mA _{P-P}
Minimum Modulation Current				8		mA _{P-P}
Maximum Electrical Rise/Fall Time (20% to 80%)		Measured using 15 Ω effective termination, Imod = 8mA _{P-P} to 80mA _{P-P}		96		ps
Total Jitter		PRBS15, 2.488Gbps, I _{MOD} = 8mA _{P-P} to 80mA _{P-P} , differential electrical measurement		65	175	mUI _{P-P}
Deterministic Jitter		PRBS15, 2.488Gbps, I _{MOD} = 8mA _{P-P} to 80mA _{P-P} , differential electrical measurement		45		mUI _{P-P}
Random Jitter		PRBS15, 2.488Gbps, I _{MOD} = 8mA _{P-P} to 80mA _{P-P} , differential electrical measurement		1.11		mUI _{RMS}
Maximum Bias Current				90		mA

BURST TIMINGS

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
		Disable: Bias current reduced to 20% of its maximum value.				
Burst Enable/Disable Time (Electrical)		Enable: Bias current increased to 90% of desired bias + modulation current		7	12	ns
		Target bias current > 3mA				
Minimum Burst Length to Update APC Loop		During closed-loop operation		90		ns
Minimum Burst Gap		During closed loop operation		75		ns
Maximum Initial Mean Power Control Settling Time (APC Loop)		From power-on, negation of TX_DISABLE, or negation of SLEEP to 90% of desired optical power. Fast settling algorithm enabled, no fast start LUT.		1.2		μs
		Bias current overshoot < 10%				
		Bias current > 4mA				

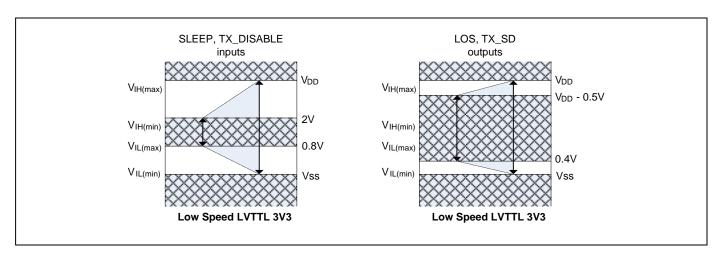
TRANSMITTER INPUT CHARACTERISTICS



Typical I/O ranges for TX_IN and BEN are shown. TX_IN and BEN inputs are also compatible with HSTL and SSTL for low voltage operation.

DIGITAL I/O CHARACTERISTICS

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Time to Initialize		From power-up or hot-plug		71		ms
TX_DISABLE Assert		TX_DISABLE assert to optical disable		0.3		μs
TX_DISABLE Negate		TX_DISABLE negate to optical enable		0.5		ms
TX_DISABLE to Reset		Time TX_DISABLE must be held high to reset TX_FAULT		0.155		μs
Maximum Delay BEN Change to TX_SD Response		Rising or falling edge		100		ns
Light During Gap To Laser Shutdown		Rogue ONU		100		μs



Typical I/O Ranges for SLEEP, TX_DISABLE, LOS, and TX_SD

PERIPHERAL FUNCTIONS

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
		Module 3V3 supply voltage above which reset will not be asserted			2.5	V
Power-On Reset (POR) Voltage		Module 3V3 supply voltage below which reset is guaranteed	2.2			V

DAC CONTROL

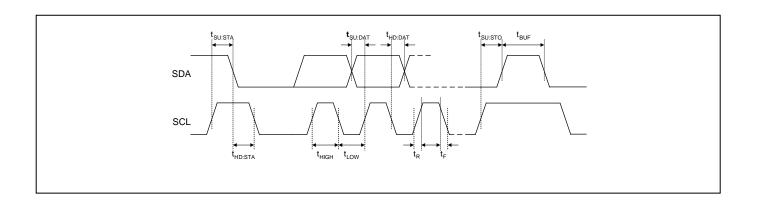
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
DAC Pin Minimum Current				0		mA
DAC Pin Maximum Current				0.45		mA
DAC Pin Compliance				1.5		V

SLEEP

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Sleep Assert/Deassert		Time to allow first operation or enter sleep from deassertion of sleep pin		100		ns

TWO-WIRE INTERFACE CHARACTERISTICS

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Maximum SCL Clock Frequency				400		kHz
Minimum SCL Clock LOW Period	t _{LOW}			1200		ns
Minimum SCL Clock HIGH Period	t _{HIGH}			600		ns
Minimum Setup Time For A Repeated START Condition	t _{SU:STA}			600		ns
Minimum Hold Time (Repeated) START Condition	t _{HD:STA}			600		ns
Minimum Data Hold Time	t _{HD:DAT}			0		ns
Minimum Data Setup Time	t _{SU:DAT}			100		ns
Minimum Setup Time For STOP Condition	t _{su:sto}			600		ns
Minimum Bus Free Time Between A Stop And Start Condition	t _{BUF}			1200		ns
Maximum Rise And Fall Times Of Both SDA And SCL Signals	t _R , t _F			300		ns
Minimum Rise And Fall Times Of Both SDA And SCL Signals	t _{R,} t _F	C_B = capacitance of a single bus line, C_X = 20 + 0.1 x Cb		C _X		ns
Maximum Capacitance For Each I/O Pin				10		pF

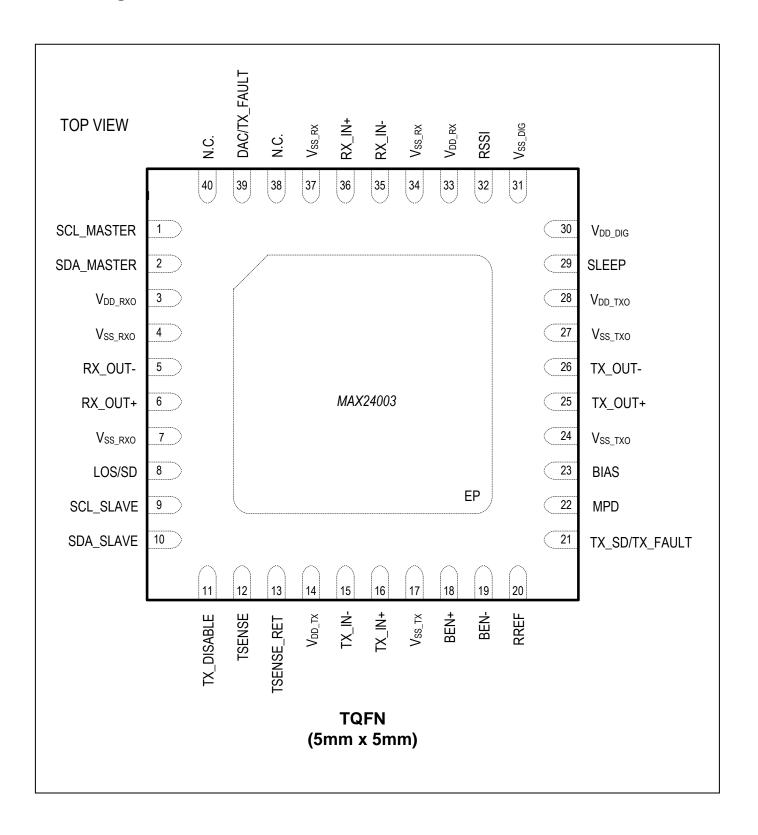


DIGITAL DIAGNOSTICS

PARAMETER	TER SYMBOL CONDITIONS MIN TYP		MAX	UNITS	
TEMPERATURE					
Reporting Resolution		-40°C to +95°C range	0.85		°C/LSB
Maximum Inaccuracy		Single-point calibration, external mode	±2		°C
POWER SUPPLY					•
Reporting Resolution		3.0V to 3.6V range	10		mV/LSB
Maximum Inaccuracy		Calibrated, within the supply reporting range	±3		%
TX BIAS					
Reporting Resolution		5mA to 90mA range	0.392		mA/LSB
Maximum Inaccuracy		Calibrated, within the Tx bias reporting range	±10		%
TX POWER					
		mpd_range = 00, 40μA to 200μA	0.78		μA/LSB
MPD Current Reporting Resolution		mpd_range = 01, 100μA to 800μA	3.125		μA/LSB
		mpd_range = 10, 400μA to 2000μA	12.5		μA/LSB
Maximum Inaccuracy		Calibrated, within the MPD operating range	±20		%
RX POWER					
		0 to 16μA (Note 4)	0.5		μA/LSB
RSSI Current Reporting Resolution		16μA to 206μA (Note 4)	2.0		μA/LSB
		206μA to 1000μA (Note 4)	8.0		μA/LSB
Maximum Income		3μA to 25μA, calibrated (Note 4)	±25		%
Maximum Inaccuracy		25μA to 1000μA, calibrated (Note 4)	±10		%

Note 4: rx_rssi_scale = 00 (x1 gain) range and resolution settings is changed to improve accuracy.

Pin Configuration



Pin Description

PIN	NAME	DIR	TYPE	FUNCTION
1	SCL_MASTER	O/P	LVTTL	Two-wire interface clock connection to EEPROM, with internal $10k\Omega$ pullup resistor
2	SDA_MASTER	I/O	LVTTL	Two-wire interface data connection to EEPROM, with internal 10kΩ pullup resistor
3	V_{DD_RXO}	Analog	+3.3V	Receiver output power supply
4	V _{SS_RXO}	Analog	GND	Receiver output ground connection
5	RX_OUT-	O/P	CML	Limiting receiver inverted output. 50Ω to V_{DD_RXO}
6	RX_OUT+	O/P	CML	Limiting receiver non-inverted output. 50Ω to V_{DD_RXO}
7	V_{SS_RXO}	Analog	GND	Receiver output ground connection
8	LOS/SD	O/P	LVTTL	Loss-of-signal indication, open drain with external $4.7k\Omega$ to $10k\Omega$ resistor.
9	SCL_SLAVE	I/P	LVTTL	Two-wire interface clock connection to host, with external 10kΩ pullup resistor
10	SDA_SLAVE	I/O	LVTTL	Two-wire interface data connection to host, with external 10kΩ pullup resistor
11	TX_DISABLE	I/P	LVTTL	Internally pulled high to V _{DD_TX} with a 7.5kΩ resistor
12	TSENSE	Analog	Analog	Temperature sensor current force
13	TSENSE_RET	Analog	Analog	Temperature sensor current return
14	V_{DD_TX}	Analog	+3.3V	Transmitter power supply
15	TX_IN-	I/P	High Speed	Transmitter input signal inverted
16	TX_IN+	I/P	High Speed	Transmitter input signal noninverted
17	V _{SS_TX}	Analog	GND	Transmitter ground connection
18	BEN+	I/P	High Speed	Burst enable noninverted
19	BEN-	I/P	High Speed	Burst enable inverted
20	RREF	Analog	Analog	Connects to external precision resistor
21	TX_SD/ TX_FAULT	O/P	LVTTL	Push-pull signal detect indication. Configured as open-drain TX_FAULT output, pulled high externally using a 4.7k Ω to 10k Ω resistor.
22	MPD	I/P	Analog	Monitor photodiode input
23	BIAS	Analog	Analog	Bias current sink
24	V _{SS_TXO}	Analog	GND	Transmitter output ground connection
25	TX_OUT+	O/P	High Speed	Laser data differential drive output
26	TX_OUT-	O/P	High Speed	Laser data differential drive output
27	V_{SS_TXO}	Analog	GND	Transmitter output ground connection
28	V_{DD_TXO}	Analog	+3.3V	Transmitter output power supply
29	SLEEP	I/P	LVTTL	Sleep mode select
30	V_{DD_DIG}	Analog	+3.3V	Digital power supply
31	V_{SS_DIG}	Analog	GND	Digital ground connection
32	RSSI	I/P	Analog	Rx photodiode monitor (RSSI)
33	V_{DD_RX}	Analog	+3.3V	Receiver power supply
34	V_{SS_RX}	Analog	GND	Receiver ground connection
35	RX_IN-	I/P	CML	Receiver input signal. Differential 100Ω with RX_IN+.
36	RX_IN+	I/P	CML	Receiver input signal. Differential 100Ω with RX_IN
37	V _{SS_RX}	Analog	GND	Receiver ground connection
38	N.C.	_	_	No connection
39	DAC/TX_FAULT	O/P	Analog	Current output for APD loop control. Configured as open-drain TX_FAULT output, pulled high externally using a $4.7 k\Omega$ to $10 k\Omega$ resistor.
40	N.C.	_	_	No connection
_	EP	Analog	GND	Exposed pad. Solder to board to provide effective thermal connection to circuit board

Detailed Description

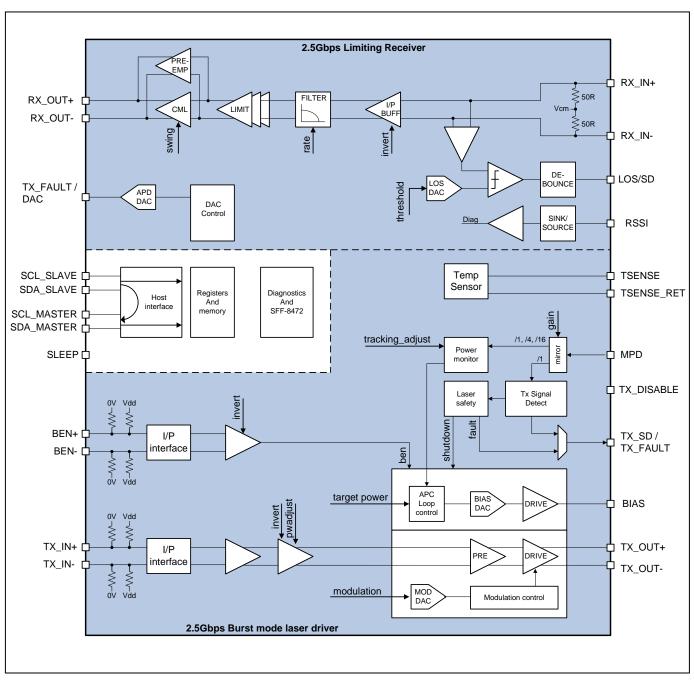


Figure 1. MAX24003 Block Diagram

Receiver Signal Path

[Control register address range A4h: 90h-93h]

The signal arriving at RX_IN is terminated with a 100Ω load to minimise return loss. An input buffer adds peaking to compensate for up to 10mm of FR4. The level of peaking is controlled by the rx_input_peak register. The signal can also be inverted using rx_invert.

rx_ratesel0 or rx_ratesel1	BANDWIDTH (GHz)	BIT RATE (Gbps)
00	1	1.25
01	1.8	2.488

The received signal is then band limited to one of two rates selected by the **soft_rate_select** bit of the **system_control** register (A2h: 7Bh). If **soft_rate_select** = '0' then select **rx_ratesel0** else select **rx_ratesel1**. Filter bandwidths are nominally designed to be 0.7x the available data rates.

The CML output stage is a high current driver capable of delivering a 200mV to 880mV signal from a low-impedance 50Ω output. The **rx_output_swing** register is used to control the signal at RX_OUT with 45mV resolution. Pre-emphasis may also be applied to the output signal using **rx_preemphasis**. The pre-emphasis (defined as ((B-A)/B) x 100) is set to 0%, 2%, 6% or 10%. The pre-emphasis ratio remains relatively constant when A is adjusted.

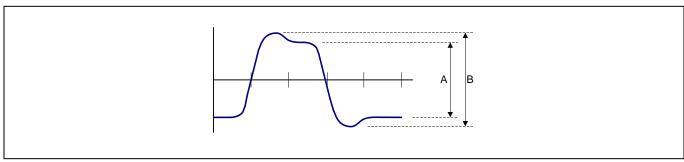


Figure 2. Rx Pre-Emphasis Control

The CML, pre-emphasis, and limiting stages may be automatically powered down under loss-of-signal conditions (LOS = '1') by setting the **los_squelch** register. This feature uses the debounced LOS signal prior to any inversion caused by setting **los_invert**. Alternatively, the CML, pre-emphasis and limiting stages may be directly powered down by setting the **squelch** register.

Receiver Loss of Signal (LOS)

[Control register address range A4h: 9Bh-9Dh]

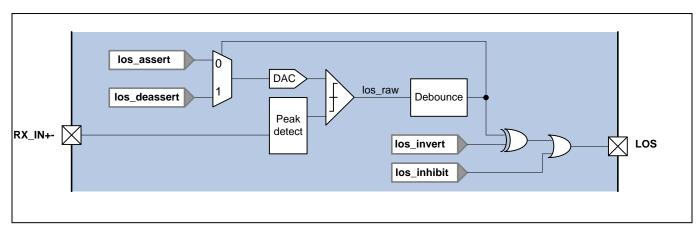


Figure 3. LOS Detection System

When the peak signal amplitude detected at RX_IN drops below the threshold level set by **los_assert** then a loss-of-signal condition is reported on the LOS pin and the **los_deassert** threshold is selected. The signal amplitude must then rise back above the threshold set by **los_deassert** before the loss-of-signal condition is removed and the **los_assert** threshold is reselected. The two thresholds are used to introduce a wide range of hysteresis into LOS detection. The deassert threshold level should be higher than the assert threshold for correct operation.

When the comparator output (los_raw) changes, the LOS debounce circuit holds the new value at its output for a programmable period of time controlled by **los_debounce**. Longer debounce timeout periods may be required to accommodate the much longer timeframe pulses caused by the response of the TIA AGC when the signal is suddenly interrupted. The decay of the differential signal is characterized by an unwanted signal crossover as shown in the diagram below. The unwanted pulse on los_raw is rejected by setting the debounce period to $> 50\mu s$.

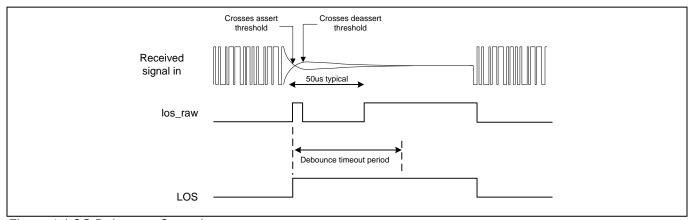


Figure 4. LOS Debounce Operation

The **los_invert** register is used to configure the pin for signal detect (SD) instead of LOS. An output mask (**los_inhibit**) holds the output to the LOS pin high after power-on reset until the configuration register load from EEPROM or microcontroller is complete. This avoids multiple transitions on the LOS pin during initialization, which can cause fault conditions to occur at the system level.

Transmitter Signal Path

[Control register address range A4h: 9Eh-A1h]

The input to the transmitter signal path supports CML, LVPECL, HSTL, and SSTL electrical signalling schemes with a minimum of external components. The input may be either DC or AC coupled. An external 100Ω resistor provides differential termination. The internal potential dividers set the common mode level at 2.0V when the input is AC-coupled.

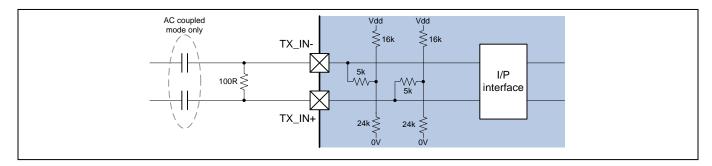


Figure 5. TX_IN and BEN Input Termination and Signal Conditioning

The laser modulation current is controlled by the **tx_moddac** register with a resolution of 375µA per LSB (nominally). This register may be set by the host, or alternatively set the **modlut_en** bit to cause the **tx_moddac** register to be automatically refreshed from the modulation lookup table (LUT) every 10 ms. The modulation LUT is stored in external EEPROM at TWI slave address A6h, register address range 80h to FFh. It is indexed using the upper 7 bits of **temperature_uncal**.

If the **modramp_en** register is set then the value in **tx_moddac** ramps progressively from the old value to the new value by one LSB every cycle of the internal 64MHz clock. This prevents glitches from occurring in the DAC. If ramping is disabled then updates to **tx_moddac** are effective immediately. The modulation current is switched off between bursts and when the laser safety system asserts a shutdown. **burst_invert** is used to invert the differential signal on BEN±. **tx_invert** is used to invert the polarity of the transmit signal path.

Eye Optimisation

The pulse width of the transmitted signal is adjusted by moving the crossing point of the eye up or down using tx_pwadjust_dir. Use the tx_pwadjust_size to control the amount of adjustment, in the direction set by tx_pwadjust_dir. At maximum adjustment, the zero crossing point (a) is moved by 40% of the 0-pk eye opening (b). The tx_pwadjust_hires register is used to halve the adjustment step size and thus increase resolution (at the expense of halving the range).

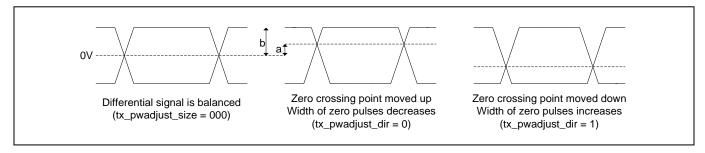


Figure 6. Crossing Point Adjustment

The **tx_snubber** register is used to snub out overshoot or undershoot in the output eye.

Tx Signal Detect

The Tx Signal Detect feature comprises two related areas of functionality:

For external signal and rogue ONU fault detect by the host, the MAX24003 controls the TX_SD pin as follows: TX_SD = '1' when there is light; TX_SD = '0' when there is no light from the laser.

For on-chip "Rogue ONU fault detect", the MAX24003 detects the presence of light during the burst gap. This fault condition is input to the laser safety system which can then optionally shut down the laser within 100µs of light being detected.

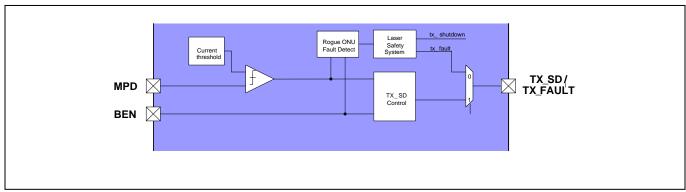


Figure 7. TX_SD Pin Signal Generation

The MPD current is compared with a threshold current set by the **txsd_threshold** register. This determines the MPD current level at which both TX_SD and rogue ONU are detected.

When BEN = '0' the TX_SD logic transfers the comparator output directly through to tx_sd. In addition, the Rogue ONU Fault Detect logic transfers the comparator output through to the laser safety system. The txsd_rogueonu_delay register specifies the delay (in cycles of the internal 64MHz clock) between the falling edge of BEN and testing for rogue ONU. The rogue_onu_fault condition is not generated during this time.

When BEN = '1' the TX_SD logic output goes high when the input from the comparator goes high. This state is latched. The tx_sd signal will then remain high until either the end of the burst, or until the comparator output remains low for a period of time exceeding the time defined by the tx_sd from toggling during a burst due to the pattern sensitivity of the MPD current. (During bias loop faststart, tx_sd is held at '1')

Selection between TX_SD and TX_FAULT functionality is governed by the **txsd_select** register. The **txsd_allow** register holds the pin high until the configuration register load from EEPROM (or microcontroller) is complete. This avoids multiple transitions on the TX_SD pin during initialization.

Rogue ONU Behaviour

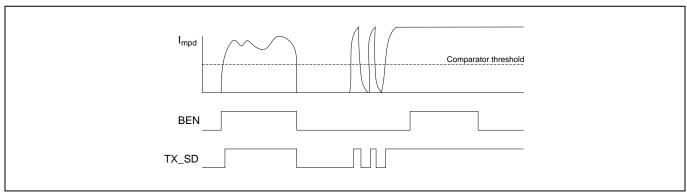


Figure 8. Rogue ONU Timing

TX_SD Behaviour

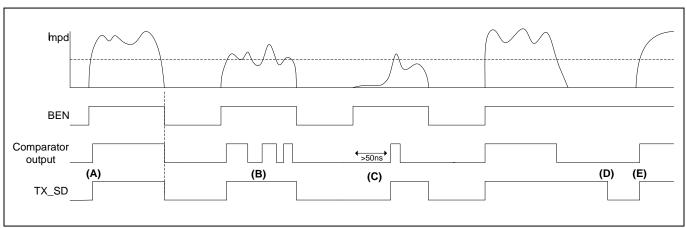


Figure 9. TX Signal Detect Timing

During the gaps, the TX_SD logic is transparent and the comparator output is routed directly through to the TX_SD pin.

During the bursts:

- (A) The TX_SD pin is asserted high when the MPD current first exceeds the threshold.
- (B) The TX_SD pin will not toggle in response to short term fluctuations of the MPD current above and below the threshold (due to the pattern sensitivity of the MPD current).
- (C) There is a requirement that the TX_SD pin responds within 50ns of the assertion of BEN. The MPD current is settled and the TX_SD circuitry can respond well within 50ns of the start of a burst. However, the MAX24003 will assert TX_SD high whenever a signal is detected during a long burst even if the signal does not appear until well after the initial 50ns.
- (D) If the laser stops outputting light during a burst, then there is a delay before TX_SD goes low. This is necessary to distinguish between the MPD current dipping below threshold due to a run of zeros, and the MPD current dropping below threshold due to a legitimate loss of signal. The delay is programmable using txsd_deglitch_period. (E) If the signal is restored during a burst then TX_SD is asserted high again.

Laser Biasing

[Control register address range A4h: A2h-A9h]

The bias current is controlled by the **tx_biasdac** register in one of six operating modes:

OPERATING MODE	DESCRIPTION	tx_biasmode <2:0>
Open loop, static	tx_biasdac only changes when it is written by the host.	000
Open loop, LUT	tx_biasdac is constantly refreshed from values read from a temperature indexed lookup table (the bias LUT)	001
Closed-loop, natural start	An automatic power control (APC) loop constantly adjusts tx_biasdac to maintain a target laser output power level. tx_biasdac defaults to near-zero after power up and then converges naturally on the target level over a duration of time dictated by the loop bandwidth.	100
Closed-loop, LUT start	The APC loop controls tx_biasdac, and tx_biasdac is preloaded from the bias LUT at power up.	101
Closed-loop, fast start	The APC loop controls tx_biasdac, and a faststart algorithm is invoked at power up to rapidly converge the loop on the target power level.	110
Closed-loop, LUT fast start	The APC loop controls tx_biasdac. tx_biasdac is preloaded from the bias LUT at power up, and then a faststart algorithm is invoked to rapidly converge the loop on the target power level.	111

Operational Overview

The **tx_biasmode<2:0>** register is a grouping of three individual controls registers:

tx_biasmode<0>: bias_lut_enable
tx_biasmode<1>: faststart_enable
tx biasmode<2>: apc enable

Open-Loop Operation

Clear the apc_enable register for open-loop operation.

The laser bias current is controlled by the **tx_biasdac** register with a resolution of 92.5µA per LSB (nominal). This register may be set by the host, or alternatively set the **bias_lut_enable** bit to cause the **tx_biasdac** register to be automatically refreshed from the bias lookup table (LUT) every 10ms. The bias LUT is stored in external EEPROM at TWI slave address A6h, register address range 00h to 7Fh. It is indexed using the upper 7 bits of **temperature_uncal**.

If the **biasramp_en** register is set then the value in **tx_biasdac** ramps progressively from the old value to the new by one LSB every cycle of the internal 64MHz clock. This prevents glitches from occurring in the DAC. If ramping is disabled then updates to **tx biasdac** are effective immediately.

Closed-Loop Operation

Set the apc_enable register for closed-loop operation.

The automatic power control (APC) loop compares a value of laser output power produced by the power monitoring circuits with a target level set by **tx_apc_target**. This proportional error value is scaled using the **apc_loop_gain** and is then used to adjust the value of **tx_biasdac** (which has a number of internal precision extension bits). The **apc_loop_gain** register thus controls the bandwidth of the APC loop.

Since the bandwidth of the loop is not very high, it is desirable to set the **tx_biasdac** register to a point as close as possible to the target laser power level before the APC loop takes over. This is achieved by pre-loading the **tx_biasdac** register with a value from the bias LUT and/or running a search algorithm (referred to as faststart). These actions are both triggered by the **bias_lut_enable** and **faststart_enable** bits. When these bits are set, then a table lookup or faststart will occur at the next available opportunity. Once the lookup or faststart has occurred then these bits are cleared. The host may therefore re-trigger fast/lut start by resetting **bias_lut_enable** and **faststart_enable** at any time. The bits are also set automatically as follows:

On power up: tx_biasmode is configured from EEPROM

During SLEEP: The value in faststart_after_sleep is transferred to faststart_enable

The value in bias_lut_after_sleep is transferred to bias_lut_enable

During TX_DISABLE: The value in **faststart_after_txdisable** is transferred to **faststart_enable**

The value in bias lut after txdisable is transferred to bias lut enable

Thus, the required loop behaviour when the laser is enabled is independently configured for reset, sleep mode, and tx disable. This is further illustrated in the figure below:

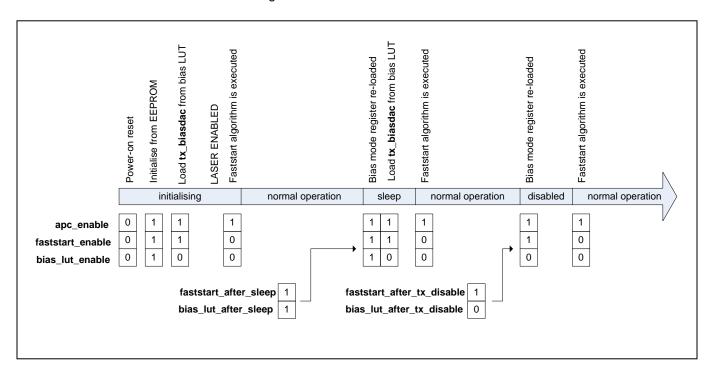


Figure 10. Behavior of the tx biasmode Register in Closed-Loop Mode

Faststart Algorithm

[Control register address range A4h: AAh-ACh]

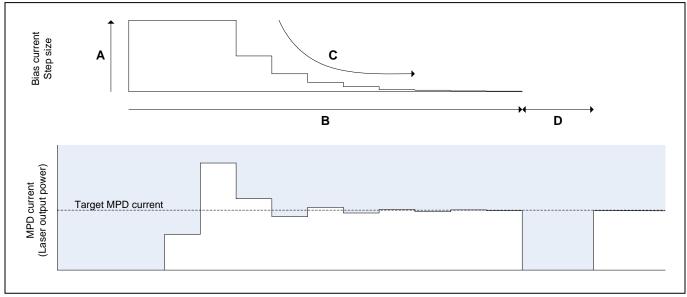


Figure 11. faststart Algorithm Timing

During faststart, the MAX24003 is temporarily re-configured. The modulation driver sinks a constant current of Imod/2 on TX_OUT to represent the contribution made by the signal current to the average power. The power monitoring circuit is re-configured to supply a direct comparison between the received MPD current and the target MPD current. The process of making a change to bias current and then a subsequent comparison of MPD current and target current is referred to as an iteration. An iteration has a fixed duration (nominally 62ns).

Initially, the bias current is stepped up on every iteration until the MPD current exceeds the threshold. The initial bias current step size A is ideally $\frac{1}{2}$ the modulation current, the rationale being that this is the largest step which is taken while ensuring that the P1 power level is not exceeded. More generally, the initial step size is defined as A = $(tx_fstart_initial/256) \times I_{MOD}$.

When the target level is exceeded the step size then decays (C). Halving the step size every iteration amounts to a binary search. In practise, incomplete settling of the loop can result in a small overshoot of the target current level. It is therefore recommended that each step is slightly more than 0.5x the previous step. This is configurable using the **fstart_decay** register. The **fstart_decay** register determines the multiplication factor applied to the step size on each subsequent iteration of the faststart algorithm.

fstart_decay	STEP DECAY MULTIPLIER
100000	32/64 = 0.5
100001	33/64 = 0.516
100010	34/64 = 0.531
100011	35/64 = 0.547
100100	36/64 = 0.563
100101	37/64 = 0.5785
101110	46/64 = 0.719
101111	47/64 = 0.734

The direction of each current step depends on whether the measured MPD current is above or below the target level. The number of iterations B is controlled by the **fstart_duration** register. The maximum number of iterations guaranteed to complete within 3 x 400ns bursts is 15.

At the end of the faststart algorithm, the laser output stage switches from sinking DC $I_{MON}/2$ on TX_OUT to full amplitude signal. This may result in a brief current spike. A facility is provided to optionally shut down the modulation current through the laser during this transition period (D). Use the **fstart_recovery_en** and **fstart_recovery_time** registers to shut down the modulation current for 0, 1, or 2 iterations.

APC Loop Bandwidth

The apc_loop_gain register adjusts the gain of the APC control loop. Loop bandwidth is calculated as a function of apc_loop_gain:

Bandwidth =
$$\frac{2^{\text{apc_loop_gain - 15}} * k_{\text{elec}} * k_{mpd} * (\text{biasdac_lsb * 4}) * f_{\text{clock}}}{2 * \pi * 16 * \text{mondac_lsb}}$$

$$= 2^{\text{apc_loop_gain - 15}} * k_{\text{elec}} * k_{mpd} * 3.02x10^{6}$$

Where: mondac_lsb = $0.78\mu A$ biasdac_lsb = $92.5\mu A$

fclock = 64MHz (typical)

kmpd = 0.0625 when mpd_range = 10 0.25 when mpd_range = 01 1 when mpd_range = 00

apc_loop_gain	GAIN
0000	2 ⁻¹⁵ 2 ⁻¹⁴ 2 ⁻¹³
0001	2 ⁻¹⁴
0010	2 ⁻¹³
:	:
1100	2 ⁻³
1101	2 ⁻³ 2 ⁻² 2 ⁻¹
1110	2 ⁻¹
1111	1

Power Monitoring

A power monitoring circuit generates a digital measure of MPD current (laser power) based on time-averaged samples taken during bursts when the laser is enabled. It has three settings to accommodate the wide range of monitor photodiode currents. The range setting (**mpd_range**) is chosen at the time that the module is calibrated, and does not change during normal operation of the APC loop. The unfiltered, 8-bit digital measure of MPD current is used internally by the APC loop.

mpd_range	PD MIRROR GAIN	I _{MON} OPERATING RANGE
00	1	40μA to 200μA
01	1/4	100μA to 800μA
10	1/16	400μA to 2000μA

Tracking error in the TOSA means that the MPD current may vary over temperature in a nonlinear way for a given laser optical power. If the temperature-indexed tracking error lookup table (LUT) is enabled then the digital measure of MPD current is multiplied by the values read from the LUT. Each entry in the LUT represents a number in the range 0.5 (00h) to 1.5 (FFh), and 80h represents unity gain.

Set the **trackinglut_en** bit to enable this feature. A correction factor is retrieved from the tracking error LUT every 10 ms. This LUT is stored in external EEPROM at TWI slave address A8h, register address range 80h to FFh. It is indexed using the upper 7 bits of **temperature_uncal**.

The digital measure of MPD current (including tracking error compensation) is used by the APC loop to control bias current.

Power Reporting

For power reporting purposes, the power monitor output is lowpass filtered to suppress the pattern sensitivity of the MPD current. This filter bandwidth is programmable using the mon_bandwidth register. Bandwidth = $64 / (2\pi x 2(15-n))$ where n is the 4-bit integer mon_bandwidth value up to a maximum of 14. The filtered measure of laser power is read from the txpower uncal register.

mon_bandwidth	BANDWIDTH AT fCLOCK = 64MHZ
0000	311Hz
0001	622Hz
 1000	 80kHz
 1110 1111	 5.1MHz No filtering

The mpd_range should be set at a level which accommodates the expected range of MPD current. The MAX24003 is not designed to automatically range switch during normal APC loop operation. However, if the APC loop fails and the power monitor saturates, then the mpd_range will temporarily switch so that power reporting can cover the full 0 to 2mA range of photodiode current. The range then recovers back to the original setting if the power monitor value drops back below 64.

Power Levelling

The power_levelling register implements GPON power levelling. Set to 00, 01, or 1x to reduce the modulation amplitude set by tx_moddac by x1, x0.5, and x0.25 respectively. This register will also reduce the power level by having the same effect on the output of the tx_apc_target register. Power levelling does not affect the bias current in open-loop mode.

Laser Safety

[Control register address range A4h: AFh-B3h]

The laser safety system generates two signals, <code>tx_fault_int</code> and <code>tx_shutdown_int</code>. <code>Tx_fault_int</code> is pure status. It reports through both the register and <code>TX_FAULT</code> pin whether one or more enabled fault conditions have occurred. The <code>TX_FAULT</code> pin is configured to appear at pin 21 or 39 using <code>pin_config0</code>. <code>Tx_shutdown_int</code> is a control signal. It disables the bias and modulation currents to the laser when one or more enabled fault conditions have occurred.

Fault Conditions

The fault conditions which affect tx fault int and tx shutdown int are:

Bias Fault This occurs when the BIAS pin is shorted to ground.

APC Fault This occurs when the MPD pin is shorted to ground.

VREF Fault This occurs when the RREF pin is shorted to ground.

VDD Fault This occurs when brownouts are detected on TX or TXO.

Tx Disable Fault Is given by: (TX_DISABLE XOR tx_disable_invert) OR soft_tx_disable where TX_DISABLE is the pin

value and soft_tx_disable is in SFF-8472 status_control.

Soft Tx Fault

This occurs when the soft_tx_fault bit in software_faults register is set.

RogueOnu Fault If the laser is on during a gap between bursts then this fault condition is generated.

Alarm Fault This occurs when one or more of the SFF-8472 DDM alarm flags are set to '1'. The flags which

contribute to Alarm Fault are programmable using ls_alarmflag_en.

When the laser is in shutdown then the bias fault condition is ignored by the laser safety system. When $tx_shutdown$ is deasserted there is a 250µs delay before the bias fault condition is used. This allows the circuit which detects a ground short on the BIAS pin time to settle before the bias fault condition is seen by the laser safety system.

Architecture

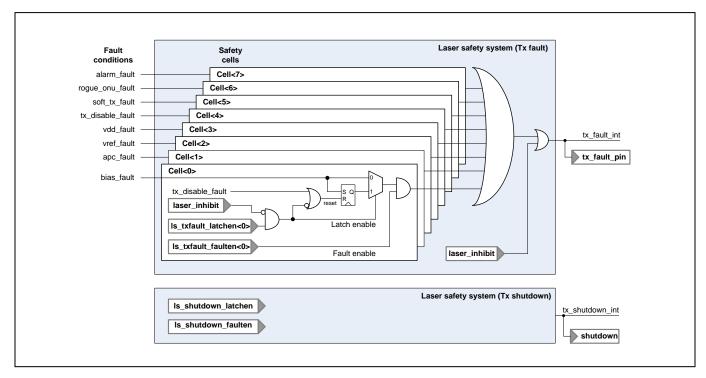


Figure 12. Laser Safety System

The laser safety system (Tx fault) generates the tx_fault_int signal. The status of this signal is accessed in the SFF-8472 **status_control** register. The signal is also multiplexed onto the TX_FAULT/TX_SD pin.

Every safety cell has its own pair of latch enable and fault enable control register bits. The fault condition can only propagate through to the output when _faulten = '1'. When _latchen = '1' a latched version of the fault condition is used. The latch is held in reset when latching is disabled or when the $tx_disable_fault$ signal is asserted. Note that $tx_disable_fault$ is also a fault condition signal.

When it is asserted, the <code>laser_inhibit</code> signal holds all latches in reset and forces the <code>tx_fault_int</code> signal to '1'. Note that after power-on reset, <code>laser_inhibit</code> is enabled. During initialization <code>pin_config</code> is the last configuration register to be loaded from EEPROM and therefore has the effect of clearing <code>laser_inhibit</code> and thus enabling the laser.

Is fault status reports the status of the fault conditions at the inputs to the safety cells.

The laser safety system is fully replicated for controlling laser shutdown. The system uses the $ls_shutdown_faulten$ and $ls_shutdown_latchen$ registers and produces the $tx_shutdown_int$ signal for disabling the modulation and bias currents. The internal architecture is otherwise the same as the system for Tx Fault. The shutdown register is found in $hardware_status$.

The module Tx supply (V_{CC_TX}) is used in some applications to shutdown the laser. This is supported in MAX24003 by detecting the removal of V_{CC_TX} on the V_{DD_TXO} pin. V_{CC_TX} is connected to V_{DD_TXO} as shown in the figure below. A shutdown is then asserted if the voltage falls below 2.7V. If the connection between V_{CC_TX} and V_{DD_TXO} is not used V_{DD_TXO} must be connected to another supply.

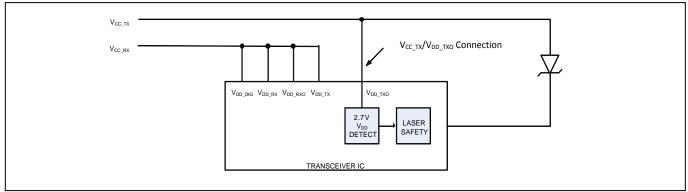


Figure 13. V_{DD TXO} Configured to Assert Laser Shutdown

Temperature Sensor

[Control register address range A4h: B6h, B9h, C1h]

The MAX24003 includes an integrated temperature sensor that reports the module temperature at the sensor transistor. The **temp_ext_sensor** register selects between an internal transistor or an external pnp transistor connected to the TSENSE and TSENSE_RET pins. If an external transistor is used then the PCB tracks connecting an external pnp transistor to the chip each have resistance < 1Ω . i.e. the tracks must be kept as short as possible. The temperature sensor reports a value in **temperature_uncal** once every 65ms. Resolution is approximately 0.8°C per LSB of **temperature_uncal**. Part-to-part accuracy is optimized by adjusting **temp_calibrate** until each part reports the same value of **temperature_uncal** at a common temperature.

Setting **leave_pu** and **tempsense_pu** enables the temperature sensor to be in a power-saving mode by powering down between reads.

DAC Output

[Control register address range A4h: 94h, 98h]

The MAX24003 features a current DAC output, which is set using a temperature-indexed LUT. The DAC is controlled from the **rx_apddac** register. This will be periodically refreshed from the APD LUT if **dac_lut_enable** is set.

This DAC is used for control of an external DC-DC converter used in APD bias voltage generation.

Digital Diagnostics

Data Generation

[Control register address range A4h: B4h to B5h, E6h to EAh]

Temperature, supply voltage, laser bias current, transmit power, and received power are all periodically sampled.

Temperature

The uncalibrated temperature is read from the **temperature uncal** register.

Supply Voltage

Select between Tx and Rx supply voltages using **adc_supplysel**, and adjust the sampling rate using **supply_bandwidth**. The uncalibrated supply voltage is read from the **supply_uncal** register.

Tx Bias Current

The bias current measured during a burst will continue to be reported between bursts, irrespective of the length of the gap. If the laser is deliberately shutdown by the laser safety system or by asserting TX_DISABLE then the bias current reports zero and the low alarm/warning flags are set. The uncalibrated bias current is read from the bias_uncal register.

Tx Power

The Tx Power measured during a burst will continue to be reported between bursts, irrespective of the length of the gap. If the laser is deliberately shutdown by the laser safety system or by asserting TX_DISABLE then Tx Power reports zero and the low alarm/warning flags are set. The uncalibrated Tx Power is read from the **txpower_uncal** register.

Rx Power

The RSSI pin both sources and sinks a current (**rx_rssi_sink**), which is proportional to the optical power incident on the receiver. Resolution is enhanced by applying additional gain (x1, x1.5, or x2) to the current at the RSSI pin using the **rx_rssi_scale** register (see **los_rssi_config**).

For Rx power measurement the ADC is used in nonlinear "3-slope" mode. This provides both wide dynamic range and high resolution at low powers. The uncalibrated, 3-slope encoded value of Rx power is read from the **rxpower_uncal** register.

RSSI CURRENT RAI	rynower uneel		
GAIN (x1)	GAIN (x1.5)	GAIN (x2)	rxpower_uncal
0 to 16 16 to 208	0 to 11 11 to 139	0 to 8 8 to 104	0 to 32 32 to 128
208 to 1232	139 to 821	104 to 616	128 to 255

Adjust the Rx Power sampling bandwidth using **rxpower bandwidth**.

Digital Diagnostic Monitors

The raw digital measures of: temperature, supply voltage, bias current, Tx Power and Rx power are converted into calibrated SFF-8472 Digital Diagnostic Monitor (DDM) values once every 10ms when sff_en is set and the main loop is active (mainloop_en is set). These registers are located in main_config. The following calibration constants are used:

METRIC	REFERENCE	SLOPE (SLA : A4h)	OFFSET (SLA : A4h)	DDM (SLA : A2h)
Temperature	temp	00h–01h	02h-03h	60h–61h
Supply Voltage	VCC	04h–05h	06h–07h	62h-63h
Tx Bias Current	bias	08h–09h	0Ah-0Bh	64h–65h
Tx Power	txpower	0Ch-0Dh	0Eh-0Fh	66h–67h
Rx Power	rxpower	10h-11h (slope 0)	12h-13h (offset 0)	68h–69h
	,	14h-15h (slope 1)	16h-17h (offset 1)	

All slope values (including Rx Power) are stored as 16-bit fixed point (unsigned) as per SFF-8472 external calibration constants. The slope is calculated as DDM LSB's per ADC increment. Eg. for supply voltage the slope unit (bit 8) represents units of 100µA per ADC increment (hence the >>8 operation after multiplication). All offset values (including Rx Power) are stored as 16-bit fixed point (signed two's complement) as per SFF-8472 external calibration constants. In all cases, the upper byte of the 16-bit word is stored at the lower address. Rx power has an additional pair of constants to support a rough piecewise linear approximation of the nonlinear characteristic of received optical power vs. RSSI current. This occurs when a series resistor is used between the APD and the APD bias voltage generation circuit. It provides a form of compression, protecting the APD by reducing avalanche gain if current gets too high.

Temperature

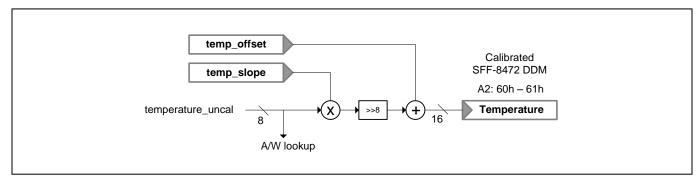


Figure 14. Calculating the Temperature DDM

Supply Voltage

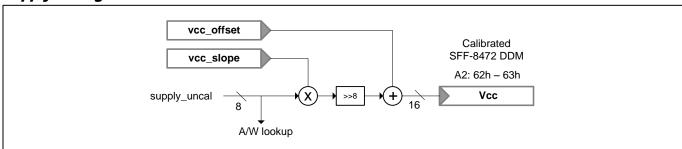


Figure 15. Calculating the Supply Voltage DDM

Tx Bias Current

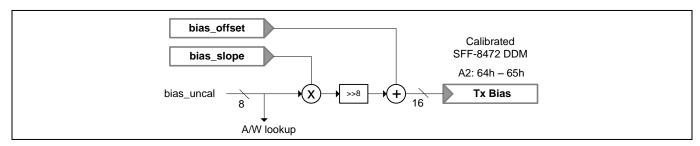


Figure 16. Calculating the Bias Current DDM

Tx Power

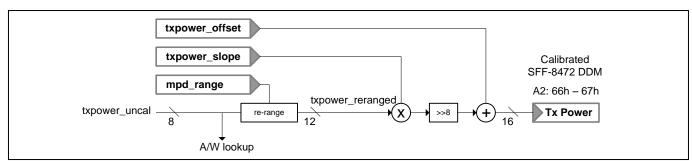


Figure 17. Calculating the Tx Power DDM

The power monitor generates an 8-bit measure of MPD current after a gain of 1, $\frac{1}{4}$, or $\frac{1}{16}$ has been applied. Reranging increases the Tx Power value when gains < 1 have been applied to the MPD current.

```
txpower_reranged = txpower_uncal << 4 when mpd_gain = '00' else txpower_uncal << 2 when mpd_gain = '01' else txpower_uncal
```

Rx Power

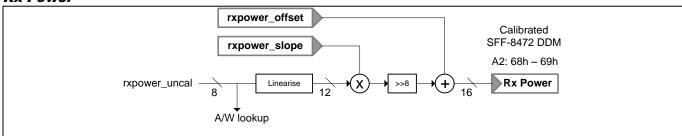


Figure 18. Calculating the Rx Power DDM

The following formulae are used to convert the 3-slope **rxpower_uncal** value into a linear pseudo 12-bit (0 to 2448) value:

```
0 < rxpower\_uncal \le 32 linearized_rx_power = rxpower_uncal 32 \le rxpower\_uncal \le 128 linearized_rx_power = ((rxpower_uncal - 32) * 4) + 32 128 \le rxpower\_uncal \le 255 linearized_rx_power = ((rxpower_uncal - 128) *16) + 416
```

The selected pair of slope and offset values depends on the value of <code>linearized_rx_power</code>. If <code>linearized_rx_power</code> is greater than <code>rxpower_threshold</code> then use the slope and offset pair from the address range 14h to 17h. Otherwise, use the slope and offset pair from address range 10h to 13h. This coarsely accommodates the nonlinearity of the curve of received optical power vs. RSSI current.

Alarm and Warning Flags

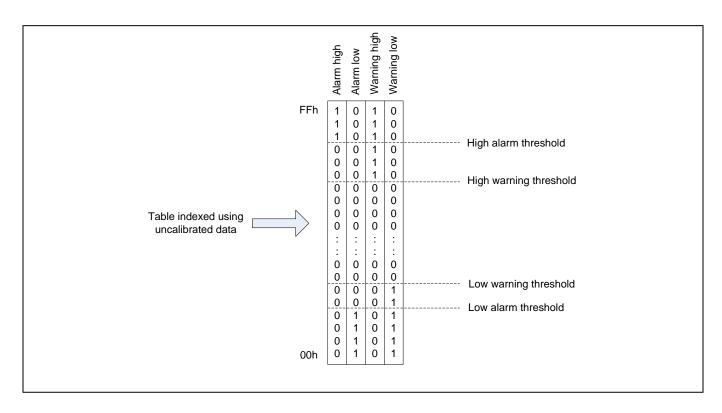


Figure 19. Using 8-Bit Calibrated Data to Look Up Alarm and Warning Flags

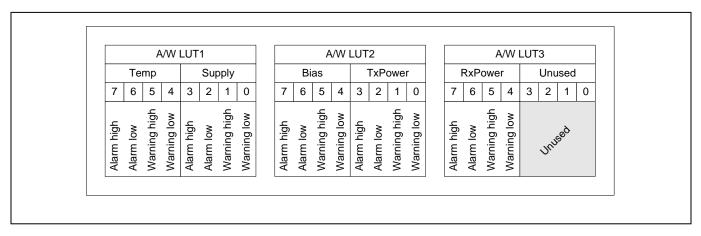


Figure 20. Alarm and Warning LUT Mapping

The uncalibrated 8-bit diagnostic data values are used to index the alarm and warning LUTs. Construct a LUT by identifying the required threshold levels in absolute units (V, C, mA, μ W) and then reverse the calculations shown by the figures in the previous section to yield corresponding uncalibrated threshold levels. For Tx and Rx power these should incorporate the range and 3-slope encoding, respectively.

The **Is_alarmflag_en** register controls which of the DDM alarm flags contribute to the laser safety alarm_fault fault condition.

Power up and Sleep Mode

[Control register address range A4h: 8Ch, B8h]

The MAX24003 is put into a low-power mode of operation when the SLEEP pin is asserted. This is achieved by combining the sleep function with the chip power sequencing, SLEEP is configured to independently affect the Rx and Tx signal paths.

Rx Signal path: The response to the SLEEP pin is controlled by the rx_respond_to_sleeppin register.

Tx Signal path: The response to the SLEEP pin is controlled by the tx_respond_to_sleeppin register.

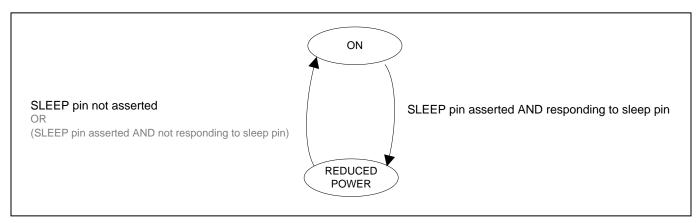


Figure 21. Conditions for Moving In and Out of Sleep Mode

The device will only move between these states when power sequencing is enabled (tx_powerup_en and rx_powerup_en are set).

The host can alternatively put the MAX24003 to sleep using the **tx_force_sleep** and **rx_force_sleep** registers.

Initialization and Control

Overview

The MAX24003 is normally used in conjunction with a 2KB EEPROM.

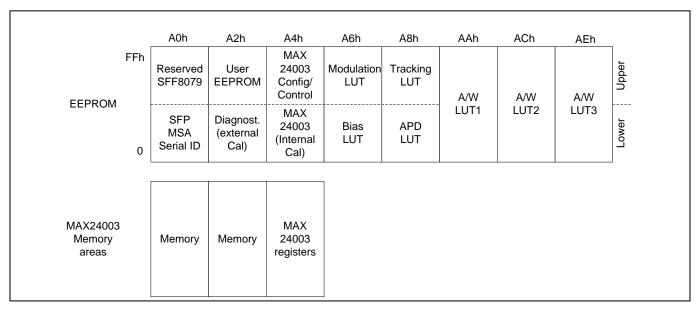


Figure 22. Address Map

Normal Operation

During initialization, data is transferred from EEPROM areas with TWI slave addresses A0h and A2h into shadow areas of memory on the MAX24003. Device configuration data is transferred from area A4h into MAX24003 registers.

During normal operation the MAX24003 has exclusive access to the lookup tables held in EEPROM using the TWI master interface. The MAX24003 TWI slave interface only decodes slave addresses A0h and A2h, and when the host accesses these areas it is accessing the shadowed memory on the MAX24003. The diagnostic data in the memory is regularly refreshed.

Using a Microcontroller

If the initialization fails then the MAX24003 defaults to a state whereby the Tx and Rx paths are not enabled, the main loop is off, and all memory areas are accessible. A microcontroller may then upload data to registers and control the operation of the MAX24003.

Module Setup

To access EEPROM (cf initialisation_status and system_control registers)

- Clear mainloop_en. This stops the main loop.
- Wait until eeprom_dma_idle is set. Accesses to EEPROM have then ceased.
- Set external_access to direct accesses via the TWI slave interface to EEPROM.

All regions of the EEPROM may then be accessed as long as the chip is in security level 2.

Access Control

[Control register address range A2h: 7Ch to 7Fh, and A4h: 82h to 8Bh]

Three levels of security are defined. The security level determines which areas of EEPROM and register space may be accessed via the two-wire interface. The security level is selected by the **password_entry** register and is read from the **security_level** register in **system_status**.

Level2 – (password_entry value matches password2). The host has full read and write access to all address spaces. (password2 has priority over password1)

Level1 – (password_entry value matches password1). The host has read and write access to A0h and A2h only, as defined by the upper nibbles of the password configA0 and password configA2 registers.

Level0 – (password_entry value matches neither password1 nor password2). The host has read and write access to A0h and A2h only, as defined by the lower nibbles of the password_configA0 and password_configA2 registers.

Password1 and **password2** can only be written in level2. The security level will not change when writing a new value to **password2**. Typically access in level 0 is more restrictive than access in level 1. Read and write access to A2h:78h to 7Fh is always permitted. If access is denied then the transaction is discarded in the case of a write, and returns FFh in the case of a read. During burst-mode accesses, access permission and destination are tested on a byte-by-byte basis.

Initialization Sequence

[Control register addresses A4h: 80h, 81h, 8Ch, E0h]

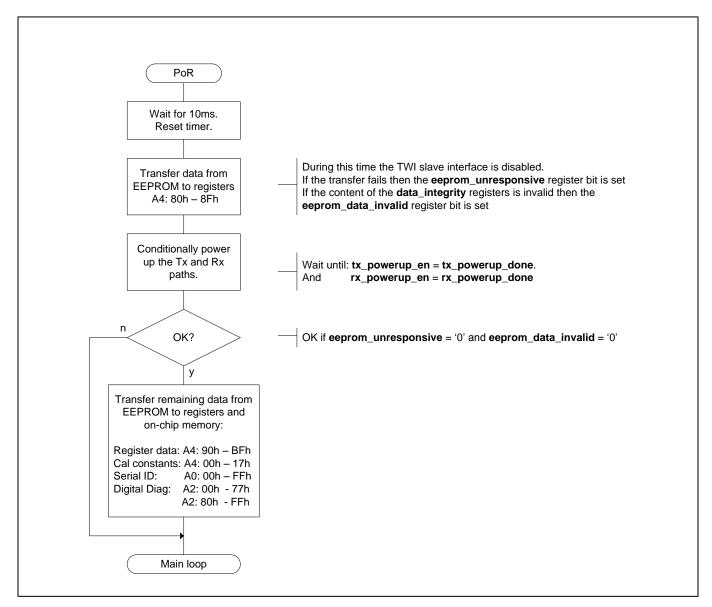


Figure 23. Initialization Sequence

The data integrity bytes are the first two bytes to be read from EEPROM (addresses A4: 80h to 81h). If data_integrity0 = C3h and data_integrity1 = 5Ah then it is inferred that the EEPROM is correctly programmed and initialization continues.

If the read access fails (no EEPROM) then **eeprom_unresponsive** is set. If the read access succeeds but the data integrity values are incorrect then **eeprom_data_invalid** is set. In both cases the transfer from EEPROM is aborted to prevent MAX24003 defaults from being overwritten with random data. The Tx and Rx paths will not power up and the MAX24003 will remain in the wait state at the start of the main loop.

The data integrity values only exist in EEPROM. They have no corresponding registers.

Main Operating Loop

[Control register address A4h: B7h] Main loop mainloop_en y Conditional – Only do this if **modlut_en** = 1 Modulation look-up Bias look-up Conditional – Only do this if biaslut_en = 1 Conditional – Only do this if **apdlut_en** = 1 APD look-up Conditional – Only do this if **trackinglut_en** = 1 Tracking error lookup Conditional – Only do this if **sff_en** = 1 Alarm/Warn look-up Conditional – Only do this if **sff_en** = 1 Trigger SFF-8472 calibration All lookups performed before laser is enabled On first pass, clear laser_inhibit Reset Wait for 10ms timer to expire. timer

Figure 24. Main Operating Loop

The modulation, bias, APD, and tracking error LUTs are all 128 bytes and indexed by the upper 7 bits of the uncalibrated temperature sensor output (**temperature_uncal**). Typically, LUT entry 14h corresponds with a temperature of -40°C. LUT resolution is then 1.6°C between consecutive table entries. These values are approximate and may vary slightly from batch to batch.

Two-Wire Interface (TWI) Protocol

The SDA_SLAVE, and SCL_SLAVE pins are referred to as the slave two-wire interface (slave TWI). The slave TWI provides external access to both registers within the MAX24003 and to any device connected to the SCL_MASTER and SDA_MASTER pins (the master TWI). Typically, an EEPROM is connected to the master TWI.

Framing and Data Transfer

The two-wire interface comprises a clock line (SCL) and a data line (SDA).

An individual transaction is framed by a START condition and a STOP condition. A START condition occurs when a bus master pulls SDA low while SCL is high. A STOP condition occurs when the bus master allows SDA to transition low-to-high when SCL is high. Within the frame the master has exclusive control of the bus. The MAX24003 supports Repeated START conditions whereby the master may simultaneously end one frame and start another without releasing the bus by replacing the STOP condition with a START condition.

Within a frame the state of SDA only changes when SCL is low. A data bit is transferred on a low-to-high transition of SCL. Data is arranged in packets of 9 bits. The first 8 bits represent data to be transferred (most significant bit first). The last bit is an acknowledge bit. The recipient of the data holds SDA low during the ninth clock cycle of a data packet to acknowledge (ACK) the byte. Leaving SDA to be pulled high on the ninth bit signals a not-acknowledged (NACK) condition. The interpretation of the acknowledge bit by the sender depends on the type of transaction and the nature of the byte being received. SDA is bidirectional so that the master may send data bytes during write transactions and the slave may send data bytes during reads.

Device Addressing

The first byte to be sent after a START condition is a slave address byte. The first seven bits of the byte contain the target slave address (MSB first). The eighth bit indicates the transaction type - '0' = write, '1' = read. Each slave interface on the bus is assigned a 7-bit slave address. If no slave matches the address broadcast by the master then SDA will be left to be pulled high during the acknowledge bit and the master receives a NACK. The master must then assert a STOP condition. If a slave identifies the address then it acknowledges it by pulling SDA low. The master then proceeds with the transaction identified by the type bit.

The two-wire interface of the MAX24003 decodes slave addresses A0h to AFh.

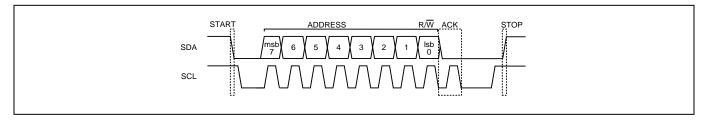


Figure 25. Address Decoding Example

Write Transaction

Figure 26 shows an example of a write transaction. The address byte is successfully acknowledged by the slave, and the type bit is set low to signify a write transaction. After the first acknowledge the master sends a single data byte. All signalling is controlled by the master except for the SDA line during the acknowledge bits. During the acknowledge cycle the direction of the SDA line is reversed and the slave pulls SDA low to return a '0' (ACK) to the master.

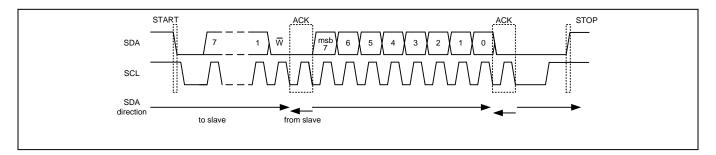


Figure 26. Write Transaction

The MAX24003 interprets the first data byte as a register address. This is used to set an internal memory pointer. Subsequent data bytes within the same transaction will then be written to the memory location addressed by the pointer. The pointer is auto-incremented after each byte. There is no limit to the number of bytes, which may be written in a single burst to the internal registers of the MAX24003.

Read Transaction

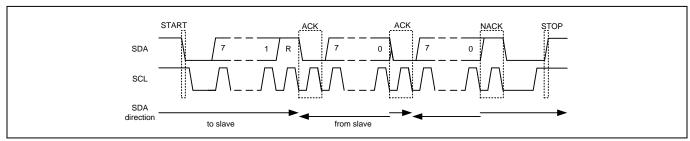


Figure 27. Read Transaction

Figure 27 shows an example of a two-byte read transaction. The slave address byte is successfully acknowledged by the slave, and the type bit is set high to signify a read. After the ACK the slave returns a byte from the location identified by the internal memory pointer. This pointer is then auto-incremented. The slave then releases SDA so that the master can ACK the byte. If the slave receives an ACK then it will send another byte. The master identifies the last byte by sending a NACK to the slave. The master then issues a STOP to terminate the transaction.

Thus, to implement a random access read transaction, a write must first be issued by the master containing a slave address byte and a single data byte (the register address) as shown in Figure 26. This sets up the memory pointer. A read is then sent to retrieve data from this address (see Figure 27).

Register Descriptions

For registers containing a single 8-bit field, the MSB of the field is stored in bit 7 of the register byte. Note that 'reserved' register bits are specified as read only. These registers should not be changed from their power-on reset (POR) default settings. Register types are:

R Bit is read only via the slave TWI. Writing to this bit will have no effect. The value may be changed by the MAX24003 to communicate operating status to the host.

R/W Bit is readable and writable via the slave TWI. The value will not be changed by the device itself except under a device reset.

E Event bit. This bit is set to '1' by the MAX24003 when a specified event occurs. It is only cleared to '0' when the host writes '1' to it via the slave TWI. Writing a zero to this register has no effect. This bit is also readable.

Slave address: A2h

6Eh	status_control			Status and control information (cf. SFF-8472 specification)
BIT	FIELD NAME	TYPE	POR	DESCRIPTION
7	tx_disable_state	R/W	0	State of the TX_DISABLE pin
6	soft_tx_disable	R/W	0	1: Disable the laser
5	_	_	_	_
4	p_down_status	R	_	State of the SLEEP pin
3	P_down_control	R/W	0	1: Assert SLEEP
2	tx_fault_state	R	_	State of the TX_FAULT pin
1	rx_los_state	R	_	State of the LOS/SD pin
0	data_ready_bar	R	1	Changes to '0' when the transceiver is powered up and data is ready

7Ah	system_status			Additional vendor specific status made available to the user irrespective of security level.
BIT	FIELD NAME TYPE POR		POR	DESCRIPTION
7	_	_	_	-
6	rogue_onu	E	0	1: Rogue_onu condition is detected
5	excessive_bias	R	0	1: Bias DAC exceeds tx_bias_threshold
4	eeprom_dma_idle	R	0	1: EEPROM is idle and may be accessed
3	eeprom_data_invalid	R	0	1: Data integrity check failed during initialization
2	eeprom_unresponsive	R	0	1: EEPROM failed to ACK the slave address during initialization
1–0	security_level	R	10	00h = level0, 01h = level1, 10h = level2

7Bh	system_control			Additional vendor specific control bits made available to the user irrespective of security level.
BIT	FIELD NAME	TYPE	POR	DESCRIPTION
7–6	_	_	_	Undefined
5–4	power_levelling	R/W	00	GPON power levelling: 00: x1, 01: x0.5, 1x: x0.25
3	soft_rate_select	R/W	0	0: ratesel0 control rx filter, 1: ratesel1 controls rx filter
2	tx_force_sleep	R/W	0	1: Force Tx system into low power SLEEP mode (if respond_to_sleep pin set)
1	rx_force_sleep	R/W	0	1: Force Rx system into low power SLEEP mode
0	external_access	R/W	0	Host access routing: 1: EEPROM, 0: internal registers/memory
	•		•	

7Ch	password_entry0	R/W	00h	Write to this register to select the security level
7Dh	password_entry1	R/W	00h	lovel 2 if password entry, password2 elec
7Eh	password_entry2	R/W	00h	level 2 if password_entry = password2 else level1 if password entry = password1 else
7Fh	password_entry3	R/W	00h	level0

Slave address: A4h

83h password1_1 R/W 00h 84h password1_2 R/W 00h 85h password1_3 R/W 00h	82h	password1_0	R/W	00h	
84h password1_2 R/W 00h	83h	password1_1	R/W	00h	Holde the contribute of 1 percentage
85h password1_3 R/W 00h	84h	password1_2	R/W	00h	noids the security level it password
	85h	password1_3	R/W	00h	

86h	password2_0	R/W	00h	
87h	password2_1	R/W	00h	Holds the security level 2 password
88h	password2_2	R/W	00h	Holds the Security level 2 password
89h	password2_3	R/W	00h	

8Ah	password_configA0			Enables the access to the upper and lower halves of the A0h address space to be configured for security levels 0 and 1.
BIT	FIELD NAME	TYPE	POR	DESCRIPTION
7	level1_write_upper	R/W	1	1: Write access to upper half of A0h permitted in security level 1
6	level1_read_upper	R/W	1	1: Read access to upper half of A0h permitted in security level 1
5	level1_write_lower	R/W	1	1: Write access to lower half of A0h permitted in security level 1
4	level1_read_lower	R/W	1	1: Read access to lower half of A0h permitted in security level 1
3	level0_write_upper	R/W	0	1: Write access to upper half of A0h permitted in security level 0
2	level0_read_upper	R/W	0	1: Read access to upper half of A0h permitted in security level 0
1	level0_write_lower	R/W	0	1: Write access to lower half of A0h permitted in security level 0
0	level0_read_lower	R/W	1	1: Read access to lower half of A0h permitted in security level 0

8Bh	password_configA2			Enables the access to the upper and lower halves of the A2h address space to be configured for security levels 0 and 1.
BIT	FIELD NAME	TYPE	POR	DESCRIPTION
7	level1_write_upper	R/W	1	1: Write access to upper half of A2h permitted in security level 1
6	level1_read_upper	R/W	1	1: Read access to upper half of A2h permitted in security level 1
5	level1_write_lower	R/W	1	1: Write access to lower half of A2h permitted in security level 1
4	level1_read_lower	R/W	1	1: Read access to lower half of A2h permitted in security level 1
3	level0_write_upper	R/W	0	1: Write access to upper half of A2h permitted in security level 0
2	level0_read_upper	R/W	0	1: Read access to upper half of A2h permitted in security level 0
1	level0_write_lower	R/W	0	1: Write access to lower half of A2h permitted in security level 0
0	level0_read_lower	R/W	1	1: Read access to lower half of A2h permitted in security level 0

8Ch	initialization_config			Early stage chip configuration at the start of the initialization process.
BIT	FIELD NAME TYPE POR		POR	DESCRIPTION
7	_	_	_	Undefined
6	_	R/W	0	Reserved
5	tx_powerup_en	R/W	0	1: Enable automatic powerup sequencing for the Tx System
4	rx_powerup_en	R/W	0	1: Enable automatic powerup sequencing for the Rx System
3–0	_	R/W	0111	Reserved

90h	rx_input			Configures the input buffer of the receive path and sets the receiver bandwidth.
BIT	FIELD NAME	TYPE	POR	DESCRIPTION
7–4	rx_input_peak	R/W	0000	0000: no peaking, increasing to 1111 for maximum peaking
3–2	rx_ratesel1	R/W	11	Sets the receiver bandwidth: 00: 1.25Gbps 01: 2.488Gbps
1–0	rx_ratesel0	R/W	00	Register is selected by soft_rate_select.

92h	rx_output			Configures the output stage of the receive path.
BIT	FIELD NAME TYPE POR		POR	DESCRIPTION
7	_	_	_	Undefined
6	los_squelch	R/W	1	1: Power down RX_OUT when LOS = 1
5	squelch	R/W	0	1: Power down RX_OUT (but only if los_squelch = '0')
4	rx_invert	R/W	0	1: Invert signal on RX_OUT
3–0	_	R/W	0000	Reserved

93h	rx_driver			Controls the output amplitude and pre emphasis on RX_OUT.
BIT	FIELD NAME TYPE POR		POR	DESCRIPTION
7–6	_	_	_	Undefined
5–4	rx_preemphasis	R/W	00	Sets pre emphasis ratio: 00: 0% 01: 2% 10: 6% 11: 10%
3–0	rx_output_swing	R/W	1010	Sets output voltage swing: 0000: 200mV pk-pk 1111: 880mV pk-pk Step size is 45mV

94h	rx_apd_control			Configuration of the APD DAC outputs.
BIT	FIELD NAME	TYPE	POR	DESCRIPTION
7–1	_	_	_	Reserved
0	dac_lut_enable	R/W	0	Load the rx_apddac register periodically from the APD LUT

086	98h rx_apddac -	TYPE	POR	DESCRIPTION
3011		R/W	00h	Sets the APD DAC output current from 0 to 500µA.

9Bh	los_rssi_config			Sets the LOS debounce period and LOS polarity. This register also contains bits used to control current on RSSI pin.
BIT	FIELD NAME	TYPE	POR	DESCRIPTION
7	_	_	_	Undefined
6–4	los_debounce	R/W	000	000 = 0μs 100 = 64μs 001 = 16μs 101 = 80μs 010 = 32μs 110 = 96μs 011 = 48μs 111 = 112μs
3–2	rx_rssi_scale	R/W	11	Sets gain applied to current flowing through RSSI pin. 00: x1: RSSI current range 0 to 1275µA 01: x1.5: RSSI current range 0 to 850µA 10: x1.5: RSSI current range 0 to 850µA 11: x2: RSSI current range 0 to 638µA
1	rx_rssi_sink	R/W	1	1: current flows into RSSI pin, 0 = current flows out of RSSI pin
0	_	_	_	_

9Ch	los assert	TYPE	POR	DESCRIPTION
9011	ios_assert	R/W	00h	Sets threshold at which LOS is asserted

9D	los deassert	TYPE	POR	DESCRIPTION
30	ios_ueassert	R/W	FFh	Sets threshold at which LOS is deasserted

9Eh	tx_input			Configures the input circuitry of the transmit path. Pulse width of the transmitted signal is adjusted by moving the crossing point of the eye up or down.
BIT	FIELD NAME	TYPE	POR	DESCRIPTION
7	burst_invert	R/W	0	1: Invert differential signal on BEN
6	tx_invert	R/W	0	1: Invert differential signal on TX_IN
5	_	_	_	Undefined
4	tx_pwadjust_hires	R/W	0	1: Reduce step size of pulse width adjust by half
3	tx_pwadjust_dir	R/W	0	0: Move crossing point of eye up, 1: Move crossing point down
2–0	tx_pwadjust_size	R/W	000	000: No adjustment, 111: Maximum adjustment. At maximum adjustment the zero crossing point moved by 40% of 0-pk eye opening.

A0h	tx_output			This register is used for managing the quality of the output eye.
BIT	FIELD NAME	TYPE	POR	DESCRIPTION
7	modramp_en	R/W	1	1: DAC ramps from old value to new, 0: Immediate step change
6–4	tx_snubber	R/W	000	Adjust this to improve rise time and pulse width distortion
3–0	_	R/W	0000	Reserved

A1h	tx moddac	TYPE	POR	DESCRIPTION
A	tx_IIIOuuac	R/W	00h	Sets the CML output current for the laser driver (modulation current)

A2h	tx_bias			The mpd_gain register applies gain to the MPD current. It does not change during normal operation and therefore the range must be selected to accommodate all expected values of mpd current.
BIT	FIELD NAME	TYPE	POR	DESCRIPTION
7	_	R/W	0	Reserved
6	_	_	_	Undefined
5-4	mpd_range	R/W	10	10: 400μA to 2000μA 01: 100μA to 800μA 00: 40μA to 200μA
3	biasramp_en	R/W	1	1: Bias DAC ramps from old to new, 0: Immediate step change
2–0	_	-		Undefined

A3h	tx_biasmode			
BIT	FIELD NAME	TYPE	POR	DESCRIPTION
7	faststart_after_sleep	R/W	0	Trigger the faststart algorithm when emerging from sleep mode
6	bias_lut_after_sleep	R/W	0	1: Do single bias LUT lookup when emerging from sleep mode
5	faststart_after_txdisable	R/W	0	Trigger the faststart algorithm when tx_disable deasserted
4	bias_lut_after_txdisable	R/W	0	Do single bias LUT lookup when tx_disable deasserted
3	_	_	_	_
2	apc_enable	R/W	0	1: Closed-loop operation. 0: Open-loop operation
1	faststart_enable	R/W	0	Trigger the faststart algorithm after power-on reset
0	bias_lut_enable	R/W	0	1: Do single bias LUT lookup after power-on reset (apc_enable = 1) 1: Periodic lookups (apc_enable = 0). 0: No lookups from bias LUT

A4h	tx_apc			The APC delay register controls the delay between the deassertion of laser shutdown and the activation of the APC loop counter. The APC loop gain sets the gain (and thus the bandwidth) of the APC control loop.
BIT	FIELD NAME	TYPE	POR	DESCRIPTION
7–4	apc_delay	R/W	0000	0000: 0µs 0001: 128µs 0010: 256µs 0011: 384µs : 1110: 1792µs 1111: 1920µs
3–0	apc_loop_gain	R/W	1000	0000: 2 ⁻¹⁵ 0001: 2 ⁻¹⁴ 0010: 2 ⁻¹³ : 1101: 2 ⁻² 1110: 2 ⁻¹ 1111: 1

		TYPE	POR	DESCRIPTION
A5h	tx_apc_target	R/W	00h	This is the MPD current target level for both the APC loop and the faststart algorithm.

		TYPE	POR	DESCRIPTION
A6h	tx_biasdac0	R/W	28h	Bits 7-0 of the 10-bit value which controls the bias current. The default is non-zero so that there is sufficient current for the loop fault detect circuits to operate correctly.

A7h	tx_biasdac1			
BIT	FIELD NAME	TYPE	POR	DESCRIPTION
7–2	_	1	_	Undefined
1–0	tx_biasdac	R/W	00	Bits 9-8 of the 10-bit value which controls the bias current

		TYPE	POR	DESCRIPTION
A8h	tx_bias_threshold	R/W	FFh	If tx_biasdac<9-2> exceeds tx_bias_threshold then the excessive_bias bit is set in system status.

A9h	tx_mon_bandwidth			Determines the bandwidth of the first order digital lowpass filter which is applied by the power monitoring circuit to the measured value of MPD current.
BIT	FIELD NAME	TYPE	POR	DESCRIPTION
7–4	_	_	_	Undefined
3–0	mon_bandwidth	R/W	1000	0000: 311Hz 0001: 622Hz 1000: 80kHz 1110: 5.1MHz 1111: No filtering

ΛΛb	AAh tx_fstart_initial	TYPE	POR	DESCRIPTION
AAII		R/W	80h	Determines the initial step size of the faststart algorithm.

ABh	tx_fstart_decay			Determines the multiplication factor applied to the step size on each step of the faststart algorithm after the MPD current first exceeds the target threshold.
ВІТ	FIELD NAME	TYPE	POR	DESCRIPTION
7–2	fstart_decay	R/W	100101	100000: 32/64 = 0.5 100001: 33/64 = 0.516 100010: 34/64 = 0.531 100011: 35/64 = 0.547 100100: 36/64 = 0.563 100101: 37/64 = 0.5785 101110: 46/64 = 0.719 101111: 47/64 = 0.734
1–0	_	_	_	undefined

ACh	tx_fstart_duration			Determines the duration of the faststart algorithm (an iteration is 4 cycles of the 64 MHz system clock) and whether the laser is shutdown for one or two cycles afterwards while the modulation control circuits settle.
BIT	FIELD NAME	TYPE	POR	DESCRIPTION
7	fstart_recovery_en	R/W	1	1: Briefly shut down bias and modulation after the faststart algorithm
6	fstart_recovery_time	R/W	0	0: Shut down for single iteration, 1: Shut down for 2 iterations
5–0	fstart_duration	R/W	001111	The faststart algorithm runs for a number of iterations specified by this register

ADh	txsd_config			Configures the TX Signal Detect feature
BIT	FIELD NAME	TYPE	POR	DESCRIPTION
7–4	txsd_rogueonu_delay	R/W	0011	The delay (in 64MHz clock cycles) between the falling edge of BEN and the testing for rogue ONU
3–2	txsd_threshold	R/W	00	MPD current level above which signal is detected during bursts and rogue ONU is detected during gaps. 00: $20\mu A$ 01: $40\mu A$ 10: $60\mu A$ 11: $80\mu A$
1	_	_	_	Undefined
0	_	_	_	Undefined

		TYPE	POR	DESCRIPTION
AEh	txsd_deglitch_period	R/W	02h	The approximate time between the loss of transmitted signal and the deassertion of TX_SD during a burst: 00h: 16ns to 31ns 01h: 31ns to 62ns 02h: 46ns to 92ns a: b to c b = (a + 1) x 15.625ns c = 2b

AFh	ls_txfault_faulten			Enables the fault conditions associated with the tx_fault laser safety system
BIT	FIELD NAME	TYPE	POR	DESCRIPTION
7	alarm	R/W	1	Enable this fault condition for the tx_fault laser safety system
6	rogue_onu	R/W	1	Enable this fault condition for the tx_fault laser safety system
5	soft_tx_fault	R/W	1	Enable this fault condition for the tx_fault laser safety system
4	tx_disable	R/W	0	Enable this fault condition for the tx_fault laser safety system
3	vdd	R/W	1	Enable this fault condition for the tx_fault laser safety system
2	vref	R/W	1	Enable this fault condition for the tx_fault laser safety system
1	apc	R/W	1	Enable this fault condition for the tx_fault laser safety system
0	bias	R/W	1	Enable this fault condition for the tx_fault laser safety system

B0h	ls_txfault_latchen			Latches the fault conditions associated with the tx_fault laser safety system
BIT	FIELD NAME	TYPE	POR	DESCRIPTION
7	alarm	R/W	1	1: Enable latching for this fault condition
6	rogue_onu	R/W	1	1: Enable latching for this fault condition
5	soft_tx_fault	R/W	0	1: Enable latching for this fault condition
4	tx_disable	R/W	0	1: Enable latching for this fault condition
3	vdd	R/W	1	1: Enable latching for this fault condition
2	vref	R/W	1	1: Enable latching for this fault condition
1	арс	R/W	1	1: Enable latching for this fault condition
0	bias	R/W	1	1: Enable latching for this fault condition

B1h	ls_shutdown_faulten			Enables the fault conditions associated with the shutdown laser safety system
BIT	FIELD NAME	TYPE	POR	DESCRIPTION
7	alarm	R/W	1	1: Enable this fault condition for the shutdown laser safety system
6	rogue_onu	R/W	1	1: Enable this fault condition for the shutdown laser safety system
5	soft_tx_fault	R/W	0	1: Enable this fault condition for the shutdown laser safety system
4	tx_disable	R/W	1	1: Enable this fault condition for the shutdown laser safety system
3	vdd	R/W	1	1: Enable this fault condition for the shutdown laser safety system
2	vref	R/W	1	1: Enable this fault condition for the shutdown laser safety system
1	арс	R/W	1	1: Enable this fault condition for the shutdown laser safety system
0	bias	R/W	1	1: Enable this fault condition for the shutdown laser safety system

B2h	ls_shutdown_latchen			Latches the fault conditions associated with the shutdown laser safety system
BIT	FIELD NAME	TYPE	POR	DESCRIPTION
7	alarm	R/W	1	1: Enable latching for this fault condition
6	rogue_onu	R/W	1	1: Enable latching for this fault condition
5	soft_tx_fault	R/W	0	1: Enable latching for this fault condition
4	tx_disable	R/W	0	1: Enable latching for this fault condition
3	vdd	R/W	1	1: Enable latching for this fault condition
2	vref	R/W	1	1: Enable latching for this fault condition
1	арс	R/W	1	1: Enable latching for this fault condition
0	bias	R/W	1	1: Enable latching for this fault condition

B3h	ls_alarmflag_en			Controls which of the DDM alarm flags contribute to the laser safety alarm_fault fault condition.
BIT	FIELD NAME	TYPE	POR	DESCRIPTION
7	temp_hifault_en	R/W	0	Alarm fault occurs when temp exceeds high temperature threshold
6	temp_lofault_en	R/W	0	Alarm fault occurs when temp below low temperature threshold
5	supply_hifault_en	R/W	0	1: Alarm fault occurs when supply exceeds high supply threshold
4	supply_lofault_en	R/W	0	1: Alarm fault occurs when supply below low supply threshold
3	bias_hifault_en	R/W	0	1: Alarm fault occurs when bias exceeds high bias threshold
2	bias_lofault_en	R/W	0	1: Alarm fault occurs when bias below low bias threshold
1	txpower_hifault_en	R/W	0	Alarm fault occurs when txpower exceeds high txpower threshold
0	txpower_lofault_en	R/W	0	Alarm fault occurs when txpower below low txpower threshold

B4h	adc_filter			The samples of supply and rxpower may be lowpass filtered using a filter with programmable bandwidth. $00: fs/(2 \times pi \times 64) = 0.25Hz$ $01: fs/(2 \times pi \times 32) = 0.5Hz$ $10: fs/(2 \times pi \times 16) = 1Hz$ $11: fs/(2 \times pi \times 8) = 2Hz$ $fs = 100Hz based on measurements every 10ms.$
BIT	FIELD NAME	TVDE		
	FIELD NAME	TYPE	POR	DESCRIPTION
7–6	— FIELD NAME	— —	POR —	Undefined
	rxpower_bandwidth	- R/W	— 00	
7–6	_	_	_	Undefined

B5h	adc_config			Configure the ADC
BIT	FIELD NAME	TYPE	POR	DESCRIPTION
7–6	_	_	_	Undefined
5–4	adc_supplysel	R/W	00	00: V _{DD_TX} 01: V _{DD_TXO} 10: V _{DD_RX} 11: V _{DD_RXO}
3–0	_	_	_	Undefined

B6h	temp_config			Configures the temperature sensor
BIT	FIELD NAME	TYPE	POR	DESCRIPTION
7	temp_ext_sensor	R/W	0	1: Use external sensor, 0: Use internal sensor
6	_	R/W	11	Reserved
5	leave_PU	R/W	1	0: Enable tempsense_pu
4–0	_	_	_	Undefined

B7h	main_config			Selects the operations performed when the main loop is enabled. Operations are performed once per iteration of the loop.
BIT	FIELD NAME	TYPE	POR	DESCRIPTION
7	biaslut_en	R/W	1	1: Load tx_biasdac register form the bias LUT
6	sff_en	R/W	1	1: Recalculate sff-8472 DDMs
5	_	_	_	Undefined
4	trackinglut_en	R/W	1	Power monitor uses values from the tracking LUT
3	apdlut_en	R/W	1	1: Load the rx_apddac register from the apd LUT
2	modlut_en	R/W	1	1: Load the tx_moddac register from the modulation LUT
1	_	_	_	Undefined
0	mainloop_en	R/W	0	1: Enable the main loop

B8h	sleep_config			Configures Sleep mode
BIT	FIELD NAME	TYPE	POR	DESCRIPTION
7–6	_	_	_	Undefined
5	_	_	_	Reserved
4	rx_respond_to_sleeppin	R/W	0	1: Power down Rx when SLEEP pin asserted, 0: Ignore SLEEP pin
3–2	_	_	_	Undefined
1	_	_	_	Reserved
0	tx_respond_to_sleeppin	R/W	0	1: Power down Tx when SLEEP pin asserted, 0: Ignore SLEEP pin

B9h	temp_calibrate			Used during calibration of temperature sensor
BIT	FIELD NAME TYPE POR		POR	DESCRIPTION
7–6	_	_	_	Undefined
5–0	temp_calibrate	R/W	011111	Calibration trim register

		TYPE	POR	DESCRIPTION
BAh	rx_power_threshold	R/W	FFh	The threshold that defines which pair of Rx Power calibration constants is used. If the 3-slope encoded sample of rx power is above this threshold then select rxpower_slope1 and rxpower_offset1. Otherwise select rxpower_slope0 and rxpower_offset0.

BEh	pin_config0			Pin function and polarity configuration
BIT	FIELD NAME TYPE POR		POR	DESCRIPTION
7	_	_	_	Undefined
6	dac_select	R/W	1	1: DAC pin 39, 0: TX_FAULT pin 39
5	txsd_select	R/W	0	1: TX_SD pin 21, 0: TX_FAULT pin 21
4	txfault_invert	R/W	0	1: Invert the signal to TX_FAULT pin, 0: No inversion
3	los_invert	R/W	0	LOS pin = 1 when signal detected and LOS pin = 0 when no signal LOS pin = 1 when no signal detected and LOS = 0 when signal
2	_	R/W	0	Reserved
1	_	R/W	0	Reserved
0	tx_disable_invert	R/W	0	1: Signal from TX_DISABLE pin is inverted, 0: No inversion

BFh	pin_config1			Masks outputs which should remain quiet during initialization
BIT	FIELD NAME TYPE POR		POR	DESCRIPTION
7–3	_	_	_	Undefined
2	txsd_allow	R/W	0	0: TX_SD disabled (= 1), 1: Normal function
1	los_inhibit	R/W	1	1: LOS disabled (= 1), 0: Normal function
0	laser_inhibit	R/W	1	1: TX_OUT and BIAS are shutdown, 0: Normal function

C0h	software_faults			This register is used to set fault conditions via the TWI
ВІТ	FIELD NAME	TYPE	POR	DESCRIPTION
7–1	_	_	_	Undefined
0	soft_tx_fault	R/W	0	Asserts the soft_tx_fault laser safety fault condition

C1h	temp_control			Configures the temperature sensor
BIT	FIELD NAME TYPE POR		POR	DESCRIPTION
7–6	_	_	_	Undefined
5	tempsense_pu	R/W	1	0: Temperature sensor powers down between reads
4–0	_	_	_	Undefined

E0h	initialization_status			Reports status associated with device initialization.
BIT	FIELD NAME TYPE POR		POR	DESCRIPTION
7	_	E	0	Reserved
6	_	_	_	Undefined
5	eeprom_dma_idle	R	0	1: EEPROM is idle and may be accessed
4	_	R	1	Reserved
3	tx_powerup_done	R	0	1: Tx path power up during initialization is complete
2	rx_powerup_done	R	0	1: Rx path power up during initialization is complete
1	eeprom_data_invalid	R	0	Data integrity check failed during initialization
0	eeprom_unresponsive	R	0	1: EEPROM failed to ACK the slave address during initialization

E1h	ls_fault_status			Reports real time status of fault conditions at input to the laser safety system	
BIT	FIELD NAME TYPE POR		POR	DESCRIPTION	
7	alarm	R	_	1: Fault condition currently exists	
6	rogue_onu	R	_	1: Fault condition currently exists	
5	soft_tx_fault	R	_	1: Fault condition currently exists	
4	tx_disable	R	_	1: Fault condition currently exists	
3	vdd	R	_	1: Fault condition currently exists	
2	vref	R	_	1: Fault condition currently exists	
1	арс	R	_	1: Fault condition currently exists	
0	bias	R	_	1: Fault condition currently exists	

E2h	ls_fault_events			Records when the fault conditions at the input to the laser safety system have been asserted. Write '1' to these bits to clear back to '0.'
BIT	FIELD NAME TYPE POR		POR	DESCRIPTION
7	alarm	E	_	1: Fault condition has occurred
6	rogue_onu	E	_	1: Fault condition has occurred
5	soft_tx_fault	E	_	1: Fault condition has occurred
4	tx_disable	E	_	1: Fault condition has occurred
3	vdd	E	_	1: Fault condition has occurred
2	vref	E	_	1: Fault condition has occurred
1	арс	E	_	1: Fault condition has occurred
0	bias	Е	_	1: Fault condition has occurred

E4h	hardware_status			Reports the real-time status of selected digital pins
BIT	FIELD NAME TYPE POR		POR	DESCRIPTION
7–5	_	_	ı	Undefined
4	txsd_pin	R	_	Indicates the status of the TXSD pin
3	tx_fault_pin	R	_	Indicates the status of the TX_FAULT pin
2	shutdown	R	_	Indicates the status of the internal shutdown signal
1	sleep_pin	R		Indicates the status of the SLEEP pin
0	tx_disable_pin	R	-	Indicates the status of the TX_DISABLE pin

E6h	temperature uncal	TYPE	POR	DESCRIPTION
Lon	E6h temperature_uncal	R		The temperature sample value before calibration

E7h	supply upgal	TYPE	POR	DESCRIPTION
E/II	supply_uncal	R	_	The supply sample value before calibration

E8h	bias_uncal	TYPE	POR	DESCRIPTION
		R	_	The bias sample value before calibration

E9h	txpower_uncal	TYPE	POR	DESCRIPTION
		R	_	The tsx_power value before re-ranging and calibration

EAh	rxpower_uncal	TYPE	POR	DESCRIPTION
		R	—s	The rxpower sample value before calibration

Simplified Interface Models

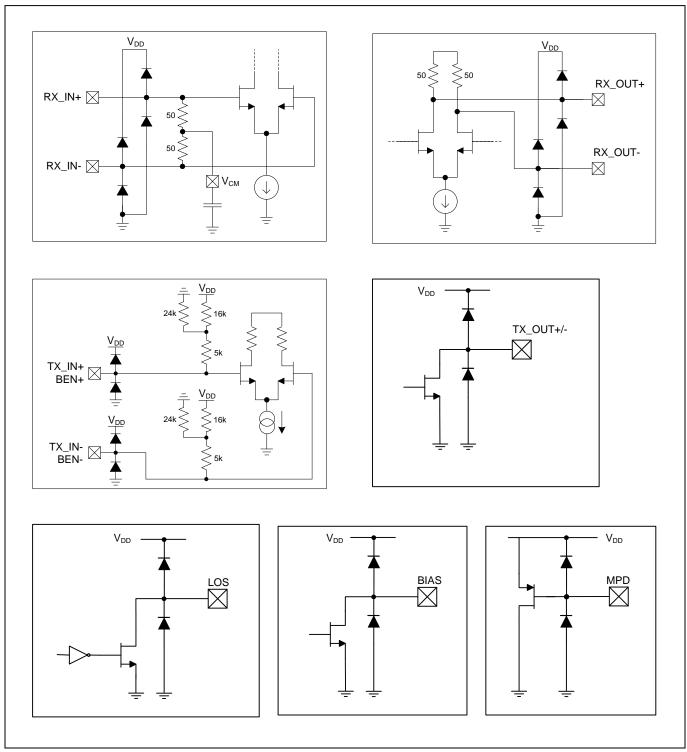


Figure 28. Interface Diagrams

ONU Application Diagrams

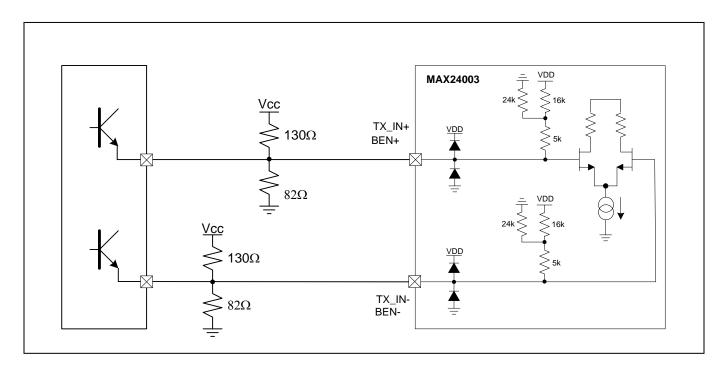


Figure 29. LVPECL External Terminations

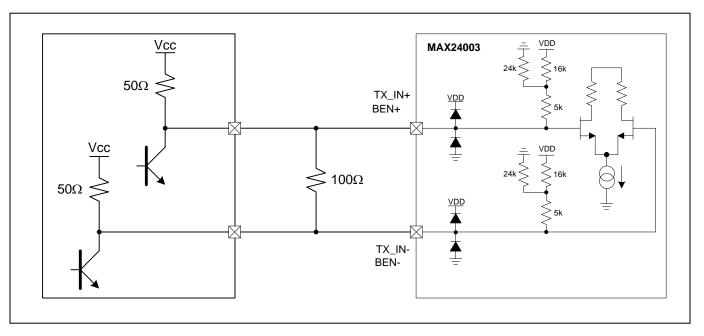


Figure 30. CML External Terminations

Package Information

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
40 TQFN-EP	T4055+2	<u>21-0140</u>	90-0002

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	12/12	Initial release	